



Docket No.: 0171-0990P
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Shoichi OSADA et al.

Application No.: 10/617,827

Confirmation No.: 5224

Filed: July 14, 2003

Art Unit: 1712

For: SEMICONDUCTOR ENCAPSULATING
EPOXY RESIN COMPOSITION AND
SEMICONDUCTOR DEVICE

Examiner: M. S. Zimmer

*Do not enter
mz*

AMENDMENT AFTER FINAL ACTION (37 C.F.R. SECTION 1.116)

MS AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated June 3, 2005, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.